

LM3480 100 mA, SOT-23, Quasi Low-Dropout Linear Voltage Regulator

General Description

The LM3480 is an integrated linear voltage regulator. It features operation from an input as high as 30V and a guaranteed maximum dropout of 1.2V at the full 100 mA load. Standard packaging for the LM3480 is the 3-lead SuperSOT® package.

The 5, 12, and 15V members of the LM3480 series are intended as tiny alternatives to industry standard LM78LXX series and similar devices. The 1.2V quasi low dropout of LM3480 series devices makes them a nice fit in many applications where the 2 to 2.5V dropout of LM78LXX series devices precludes their (LM78LXX series devices) use.

The LM3480 series features a 3.3V member. The SOT packaging and quasi low dropout features of the LM3480 series converge in this device to provide a very nice, very tiny 3.3V, 100 mA bias supply that regulates directly off the system 5V±5% power supply.

Key Specifications

- 30V maximum input for operation
- 1.2V guaranteed maximum dropout over full load and temperature ranges
- 100 mA guaranteed minimum load current
- ±5% guaranteed output voltage tolerance over full load and temperature ranges
- -40 to +125°C junction temperature range for operation

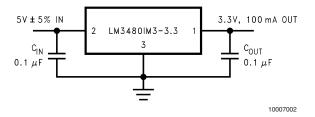
Features

- 3.3, 5, 12, and 15V versions available
- Packaged in the tiny 3-lead SuperSOT package

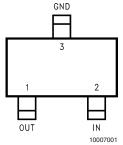
Applications

- Tiny alternative to LM78LXX series and similar devices
- Tiny 5V±5% to 3.3V, 100 mA converter
- Post regulator for switching DC/DC converter
- Bias supply for analog circuits

Typical Application Circuit



Connection Diagram



Top View
SOT-23 Package
3-Lead, Molded-Plastic Small-Outline Transistor (SOT) Package
Package Code MF03A (Note 1)

SuperSOT ® is a registered trademark of National Semiconductor.

Ordering Information

Output	Order	Package	
Voltage	Number	Marking	Comments
(V)	(Note 2)	(Note 3)	
3.3	LM3480IM3-3.3	LOA	1000 Units on Tape and Reel
3.3	LM3480IM3X-3.3	LOA	3000 Units on Tape and Reel
5	LM3480IM3-5.0	L0B	1000 Units on Tape and Reel
5	LM3480IM3X-5.0	L0B	3000 Units on Tape and Reel
12	LM3480IM3-12	L0C	1000 Units on Tape and Reel
12	LM3480IM3X-12	L0C	3000Units on Tape and Reel
15	LM3480IM3-15	L0D	1000 Units on Tape and Reel
15	LM3480IM3X-15	L0D	3000 Units on Tape and Reel

Absolute Maximum Ratings (Note 4)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Input Voltage (IN to GND) 35V

Power Dissipation (Note 5) 333mW

Junction Temp. (Note 5) +150°C

Ambient Storage Temp. -65 to +150°C

Soldering Time, Temp. (Note 6)

 Wave
 4 sec., 260°C

 Infrared
 10 sec., 240°C

 Vapor Phase
 75 sec., 219°C

ESD (Note 7) 2kV

Operating Ratings (Note 4)

Max. Input Voltage (IN to GND) 30V Junction Temp. (T_J) -40 to +125 $^{\circ}$ C Max. Power Dissipation (Note 8) 250mW

Electrical Characteristics LM3480-3.3, LM3480-5.0

Typicals and limits appearing in normal type apply for $T_A = T_J = 25^{\circ}C$. Limits appearing in boldface type apply over the entire junction temperature range for operation, -40 to +125°C. (Notes 9, 10, 11)

Nominal Output Voltage (V _{NOM})			3.3V		5.0V		11
Symbol	Parameter	Conditions	Typical	Limit	Typical	Limit	Units
V _{OUT}	Output Voltage	$V_{IN} = V_{NOM} + 1.5V,$	3.30		5.00		V
		1 mA ≤ I _{OUT} ≤ 100 mA		3.17		4.80	V(min)
				3.14		4.75	V(min)
				3.43		5.20	V(max)
				3.46		5.25	V(max)
ΔV_{OUT}	Line Regulation	$V_{NOM} + 1.5V \le V_{IN} \le 30V$,	10		12		mV
		I _{OUT} = 1 mA		25		25	mV(max)
ΔV_{OUT}	Load Regulation	$V_{IN} = V_{NOM} + 1.5V,$	20		20		mV
		10 mA ≤ I _{OUT} ≤ 100 mA		40		40	mV(max)
I _{GND}	Ground Pin	$V_{NOM} + 1.5V \le V_{IN} \le 30V$,	2		2		mA
	Current	No Load		4		4	mA(max)
V _{IN} -	Dropout Voltage	I _{OUT} = 10 mA	0.7		0.7		V
V_{OUT}				0.9		0.9	V(max)
				1.0		1.0	V(max)
		I _{OUT} = 100 mA	0.9		0.9		V
				1.1		1.1	V(max)
				1.2		1.2	V(max)
e _n	Output Noise	V _{IN} = 10V,	100		150		μV_{rms}
	Voltage	Bandwidth: 10 Hz to 100 kHz					

Electrical Characteristics (Continued) LM3480-12, LM3480-15

Typicals and limits appearing in normal type apply for $T_A = T_J = 25^{\circ}C$. Limits appearing in boldface type apply over the entire junction temperature range for operation, -40 to +125°C. (Notes 9, 10, 11)

Nominal Output Voltage (V _{NOM})		12V		15V		11	
Symbol	Parameter	Conditions	Typical	Limit	Typical	Limit	Units
V _{OUT}	Output Voltage	$V_{IN} = V_{NOM} + 1.5V,$	12.00		15.00		V
		1 mA ≤ I _{OUT} ≤ 100 mA		11.52		14.40	V(min)
				11.40		14.25	V(min)
				12.48		15.60	V(max)
				12.60		15.75	V(max)
ΔV_{OUT}	Line Regulation	$V_{NOM} + 1.5V \le V_{IN} \le 30V$,	14		16		mV
		I _{OUT} = 1 mA		40		40	mV(max)
ΔV_{OUT}	Load Regulation	$V_{IN} = V_{NOM} + 1.5V,$	36		45		mV
		10 mA ≤ I _{OUT} ≤ 100 mA		60		75	mV(max)
I _{GND}	Ground Pin	$V_{NOM} + 1.5V \le V_{IN} \le 30V$,	2		2		mA
	Current	No Load		4		4	mA(max)
V _{IN} -	Dropout Voltage	I _{OUT} = 10 mA	0.7		0.7		V
V_{OUT}				0.9		0.9	V(max)
				1.0		1.0	V(max)
		I _{OUT} = 100 mA	0.9		0.9		V
				1.1		1.1	V(max)
				1.2		1.2	V(max)
e _n	Output Noise	$V_{IN} = 10V,$	360		450		μV_{rms}
	Voltage	Bandwidth: 10 Hz to 100 kHz					

Note 1: The package code MA03B is internal to National Semiconductor Corporation and indicates a specific version of the SOT-23 package and associated mechanical drawings.

Note 2: The suffix "I" indicates the junction temperature range for operation is the industrial temperature range, -40 to +125°C. The suffix "M3" indicates the die is packaged in the 3-lead SOT-23 package. The suffix "X" indicates the devices will be supplied in blocks of 3k units as opposed to blocks of 250 units.

Note 3: Because the entire part number does not fit on the SOT-23 package, the SOT-23 package is marked with this code instead of the part number.

Note 4: Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is guaranteed. Operating Ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics tables

Note 5: The Absolute Maximum power dissipation depends on the ambient temperature and can be calculated using $P = (T_J - T_A)/\theta_{JA}$ where T_J is the junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance. The 333 mW rating results from substituting the Absolute Maximum junction temperature, 150°C, for T_J , 50°C for T_A , and 300°C/W for θ_{JA} . More power can be safely dissipated at lower ambient temperatures. Less power can be safely dissipated at higher ambient temperatures. The Absolute Maximum power dissipation can be increased by 3.33 mW for each °C below 50°C ambient. It must be derated by 3.33 mW for each °C above 50°C ambient. A θ_{JA} of 300°C/W represents the worst-case condition of no heat sinking of the 3-lead plastic SOT-23 package. Heat sinking enables the safe dissipation of more power. The LM3480 actively limits its junction temperature to about 150°C.

Note 6: Times shown are dwell times. Temperatures shown are dwell temperatures. For detailed information on soldering plastic small-outline packages, refer to the *Packaging Databook* available from National Semiconductor Corporation.

Note 7: For testing purposes, ESD was applied using the human-body model, a 100 pF capacitor discharged through a 1.5 k Ω resistor.

Note 8: As with the Absolute Maximum power dissipation, the maximum power dissipation for operation depends on the ambient temperature. The 250 mW rating appearing under Operating Ratings results from substituting the maximum junction temperature for operation, 125°C, for T_J , 50°C for T_A , and 300°C/W for θ_{JA} in $P = (T_J - T_A)/\theta_{JA}$. More power can be dissipated at lower ambient temperatures. Less power can be dissipated at higher ambient temperatures. The maximum power dissipation for operation appearing under Operating Ratings can be increased by 3.33 mW for each "C below 50°C ambient. It must be derated by 3.33 mW for each "C above 50°C ambient. A θ_{JA} of 300°C/W represents the worst-case condition of no heat sinking of the 3-lead plastic SOT-23 package. Heat sinking enables the dissipation of more power during operation.

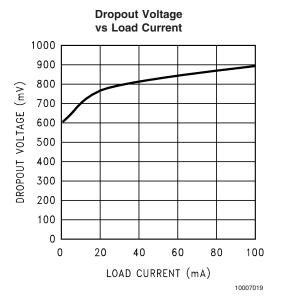
Note 9: A typical is the center of characterization data taken with T_A = T_J = 25°C. Typicals are not guaranteed.

Note 10: All limits are guaranteed. All electrical characteristics having room-temperature limits are tested during production with $T_A = T_J = 25^{\circ}C$. All hot and cold limits are guaranteed by correlating the electrical characteristics to process and temperature variations and applying statistical process control.

Note 11: All voltages except dropout are with respect to the voltage at the GND pin.

Typical Performance Characteristics

Unless indicated otherwise, V_{IN} = V_{NOM} + 1.5V, C_{IN} = 0.1 $\mu F,~C_{OUT}$ = 0.1 $\mu F,~and~T_{A}$ _=25°C.



1000 80 mA Load 900 DROPOUT VOLTAGE (mV) 800 700 600 No Load 500 400 20 mA Load 300 40 mA Load 200 60 mA Load 100 0 -50 -25 0 25 50 75 100 125 150 JUNCTION TEMPERATURE (°C) 10007020

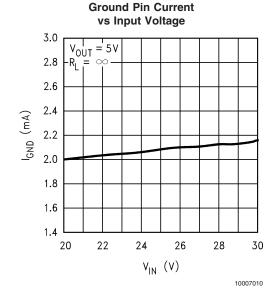
Dropout Voltage

vs Junction Temperature

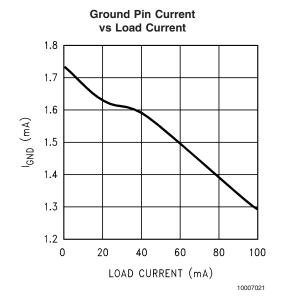
100 mA Load

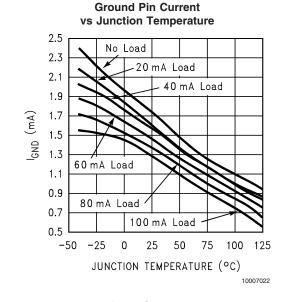
1100

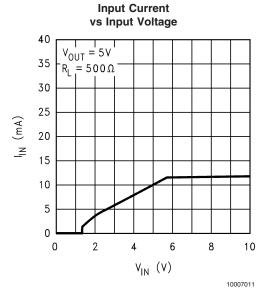
Ground Pin Current vs Input Voltage 2.0 $V_{OUT} = 5V$ $R_L = \infty$ 1.8 1.6 1.4 1.2 1.0 0.8 0.6 0.4 0.2 0 0 4 8 12 16 20 $V_{IN}(V)$ 10007009

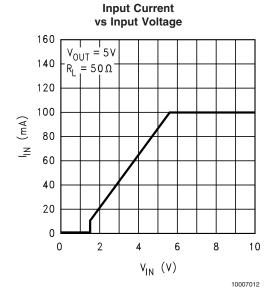


Typical Performance Characteristics Unless indicated otherwise, $V_{IN} = V_{NOM} + 1.5V$, $C_{IN} = 0.1~\mu F$, $C_{OUT} = 0.1~\mu F$, and T_A =25°C. (Continued)



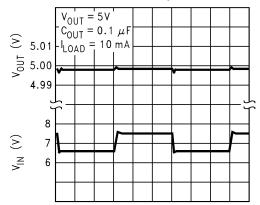






Typical Performance Characteristics Unless indicated otherwise, $V_{IN} = V_{NOM} + 1.5V$, $C_{IN} = 0.1~\mu F$, $C_{OUT} = 0.1~\mu F$, and T_A =25°C. (Continued)

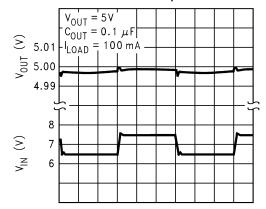
Line Transient Response



200 μ s/Div

10007003

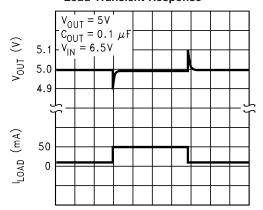
Line Transient Response



 $200 \,\mu\text{s/Div}$

10007004

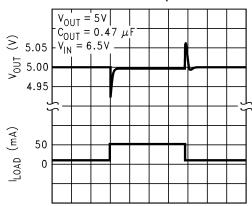
Load Transient Response



 $50 \mu s/Div$

10007005

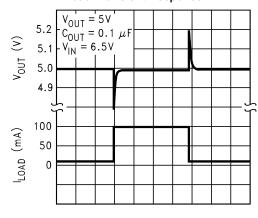
Load Transient Response



 $50 \mu s/Div$

10007006

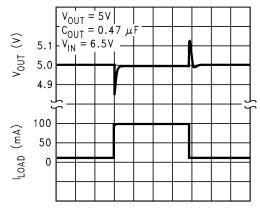
Load Transient Response



 $50 \mu s/Div$

10007007

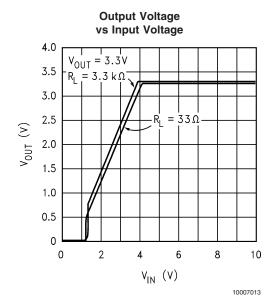
Load Transient Response

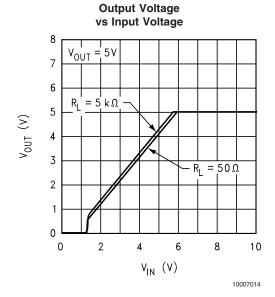


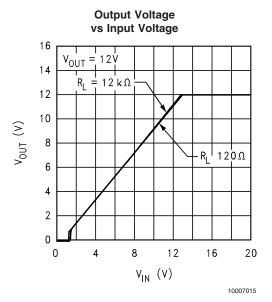
50 μs/Div

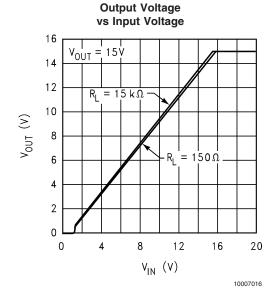
10007008

Typical Performance Characteristics Unless indicated otherwise, $V_{IN} = V_{NOM} + 1.5V$, $C_{IN} = 0.1~\mu F$, $C_{OUT} = 0.1~\mu F$, and T_{A} =25°C. (Continued)

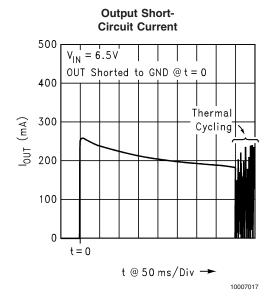


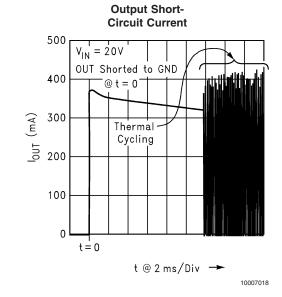


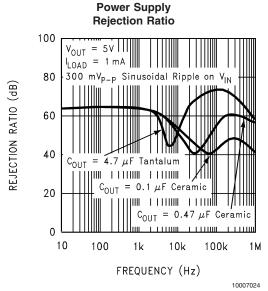


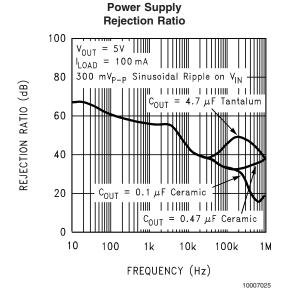


Typical Performance Characteristics Unless indicated otherwise, $V_{IN} = V_{NOM} + 1.5V$, $C_{IN} = 0.1~\mu F$, $C_{OUT} = 0.1~\mu F$, and T_A =25°C. (Continued)

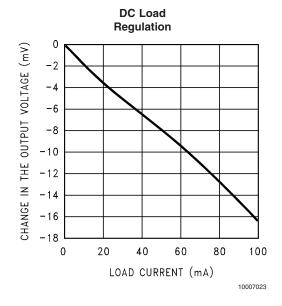






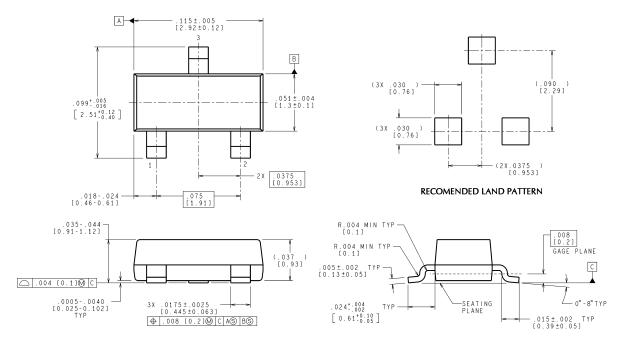


Typical Performance Characteristics Unless indicated otherwise, V_{IN} = V_{NOM} + 1.5V, C_{IN} = 0.1 μ F, C_{OUT} = 0.1 μ F, and T_{A} =25°C. (Continued)



Physical Dimensions inches (millimeters)

unless otherwise noted



CONTROLLING DIMENSION IS INCH VALUES IN [] ARE MILLIMETERS

MF03A (Rev B)

SOT-23 Package 3-Lead Small-Outline Package (M3) For Ordering, Refer to Ordering Information Table NS Package Number MF03A

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